

Cree® EZ1000™ LEDs

Data Sheet

CxxxEZ1000-Sxx000

Cree's EZBright™ LEDs are the next generation of solid-state LED emitters that combine highly efficient InGaN materials with Cree's proprietary optical design and device submount technology to deliver superior value for high-intensity LEDs. The optical design maximizes light extraction efficiency and enables a Lambertian radiation pattern. Additionally, these LEDs are die-attachable with conductive epoxy, solder paste or solder preforms, as well as the flux eutectic method. These vertically structured, low forward voltage LED chips are approximately 100 microns in height. Cree's EZ™ chips are tested for conformity to optical and electrical specifications. These LEDs are useful in a broad range of applications such as general illumination, automotive lighting, and LCD backlighting.

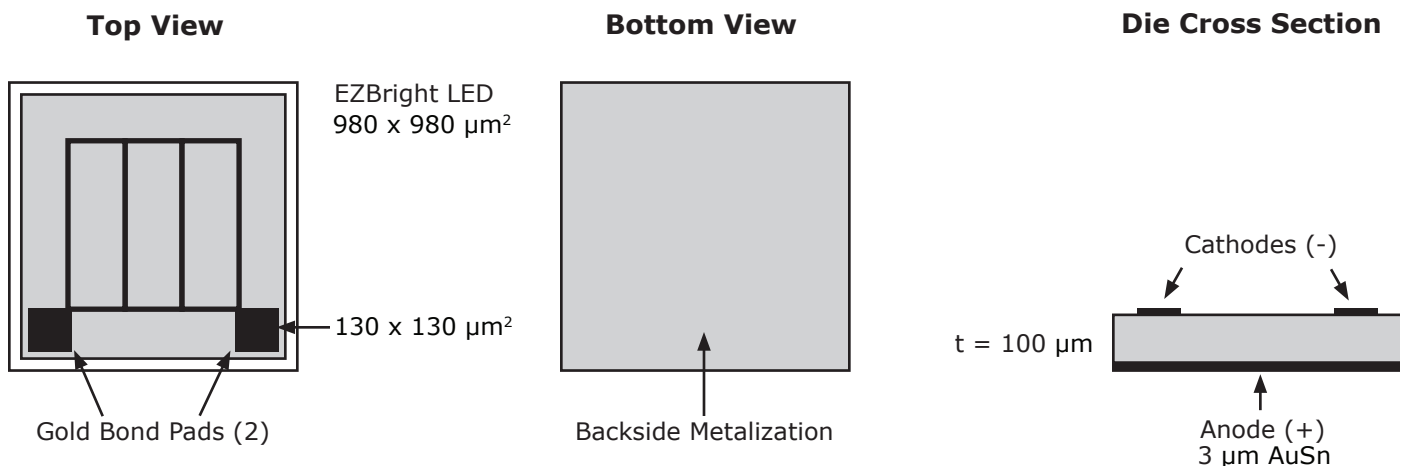
FEATURES

- EZBright LED Technology
 - 200 mW min. - 450, 460 & 470 nm
 - 300 mW min. - 450, 460 & 470 nm
 - 80 mW min. - 527 nm
 - 130 mW min. - 527 nm
- Lambertian Radiation
- Conductive Epoxy, Solder Paste or Preforms, or Flux Eutectic Attach
- Thin 100 μm Chip
- Low Forward Voltage

APPLICATIONS

- General Illumination
 - Aircraft
 - Decorative Lighting
 - Task Lighting
 - Outdoor Illumination
- White LEDs
- LCD Backlighting
- Projection Displays
- Automotive

CxxxEZ1000-Sxx000 Chip Diagram



| Maximum Ratings at $T_A = 25^\circ\text{C}$ ^{Note 1} | | CxxxEZ1000-Sxx000 |
|---|--|-------------------|
| DC Forward Current | | 1000 mA |
| Peak Forward Current (1/10 duty cycle @ 1 kHz) | | 1250 mA |
| LED Junction Temperature | | 145°C |
| Reverse Voltage | | 5 V |
| Operating Temperature Range | | -40°C to +100°C |
| Storage Temperature Range | | -40°C to +125°C |

| Typical Electrical/Optical Characteristics at $T_A = 25^\circ\text{C}$, $I_f = 350\text{ mA}$ ^{Note 2} | | | | | |
|--|------------------------------|------|------|---|---|
| Part Number | Forward Voltage (V_f , V) | | | Reverse Current [$I(V_r=5V)$, μA] | Full Width Half Max (λ_D , nm) |
| | Min. | Typ. | Max. | Max. | Typ. |
| C450EZ1000-Sxx000 | 2.9 | 3.3 | 3.8 | 2 | 20 |
| C460EZ1000-Sxx000 | 2.9 | 3.3 | 3.8 | 2 | 21 |
| C470EZ1000-Sxx000 | 2.9 | 3.3 | 3.8 | 2 | 22 |
| C527EZ1000-Sxx000 | 3.1 | 3.5 | 4.0 | 2 | 35 |

| Mechanical Specifications | | | CxxxEZ1000-Sxx000 |
|--|------------|-----------|-------------------|
| Description | Dimensions | Tolerance | |
| P-N Junction Area (μm) | 950 x 950 | ± 25 | |
| Chip Area (μm) | 980 x 980 | ± 25 | |
| Chip Thickness (μm) | 100 | ± 25 | |
| Top Au Bond Pad (μm) - Qty. 2 | 130 x 130 | +25/-10 | |
| Au Bond Pad Thickness (μm) | 3.0 | ± 1.0 | |
| Back Contact Metal Area (μm) | 980 x 980 | ± 25 | |
| Back Contact Metal Thickness (μm) | 3.0 | ± 1.0 | |

Notes:

1. Maximum ratings are package-dependent. The above ratings were determined using a Au-plated TO39 header without an encapsulant for characterization. Ratings for other packages may differ. The junction temperature should be characterized in a specific package to determine limitations. Assembly processing temperature must not exceed 325°C (< 5 seconds). See Cree EZBright Applications Note for assembly-process information.
2. All products conform to the listed minimum and maximum specifications for electrical and optical characteristics when assembled and operated at 350 mA within the maximum ratings shown above. Efficiency decreases at higher currents. Typical values given are within the range of average values expected by the manufacturer in large quantities and are provided for information only. All measurements were made using a Au-plated TO39 header without an encapsulant. Optical characteristics were measured in an integrating sphere using Illuminance E.

Standard Bins for CxxxEZ1000-Sxx000

LED chips are sorted to the **radiant flux** and **dominant wavelength** bins shown. A sorted die sheet contains die from only one bin. Sorted die kit (CxxxEZ1000-Sxx000) orders may be filled with any or all bins (CxxxEZ1000-0xxx) contained in the kit. All radiant flux and dominant wavelength values shown and specified are at $I_f = 350$ mA. Radiant flux values are measured using Au-plated TO39 headers without an encapsulant.

Blue EZ1000

EZ-200

C450EZ1000-S20000

| | | | | | | |
|----------------------------|--------|-----------------|-----------------|-----------------|-----------------|--------|
| Radiant Flux | 300 mW | C450EZ1000-0113 | C450EZ1000-0114 | C450EZ1000-0115 | C450EZ1000-0116 | |
| | 270 mW | C450EZ1000-0109 | C450EZ1000-0110 | C450EZ1000-0111 | C450EZ1000-0112 | |
| | 240 mW | C450EZ1000-0105 | C450EZ1000-0106 | C450EZ1000-0107 | C450EZ1000-0108 | |
| | 200 mW | | | | | |
| | | 445 nm | 447.5 nm | 450 nm | 452.5 nm | 455 nm |
| Dominant Wavelength | | | | | | |

C460EZ1000-S20000

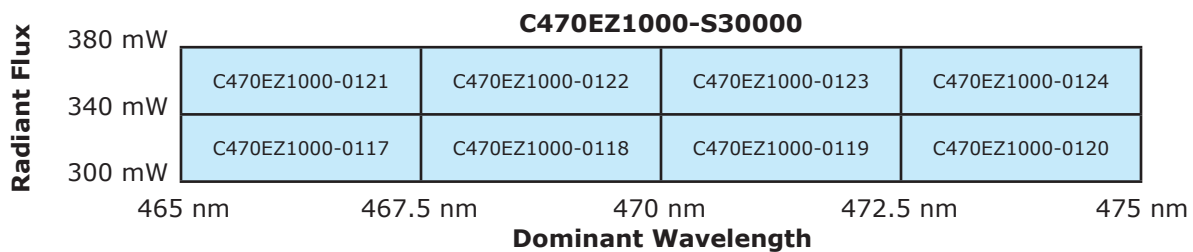
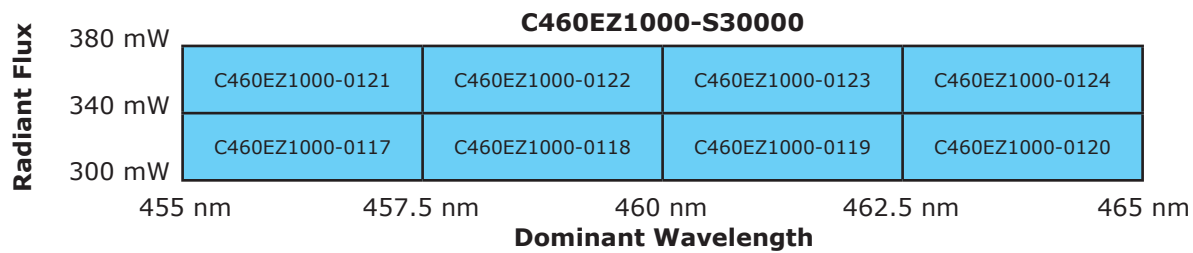
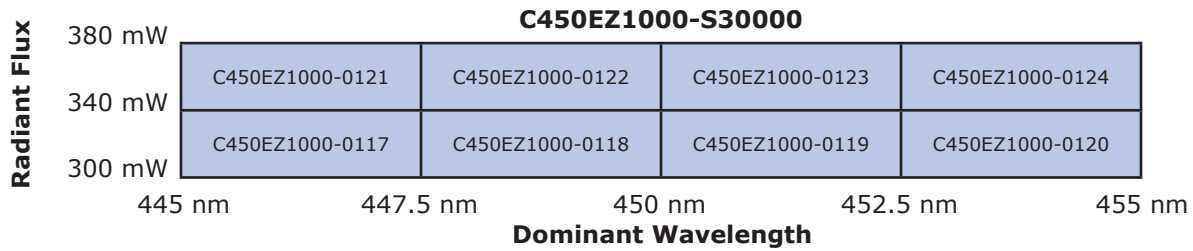
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|----------------------------|--------|-----------------|-----------------|-----------------|-----------------|--------|
| Radiant Flux | 300 mW | C460EZ1000-0113 | C460EZ1000-0114 | C460EZ1000-0115 | C460EZ1000-0116 | |
| | 270 mW | C460EZ1000-0109 | C460EZ1000-0110 | C460EZ1000-0111 | C460EZ1000-0112 | |
| | 240 mW | C460EZ1000-0105 | C460EZ1000-0106 | C460EZ1000-0107 | C460EZ1000-0108 | |
| | 200 mW | | | | | |
| | | 455 nm | 457.5 nm | 460 nm | 462.5 nm | 465 nm |
| Dominant Wavelength | | | | | | |

C470EZ1000-S20000

| | | | | | | |
|----------------------------|--------|-----------------|-----------------|-----------------|-----------------|--------|
| Radiant Flux | 300 mW | C470EZ1000-0113 | C470EZ1000-0114 | C470EZ1000-0115 | C470EZ1000-0116 | |
| | 270 mW | C470EZ1000-0109 | C470EZ1000-0110 | C470EZ1000-0111 | C470EZ1000-0112 | |
| | 240 mW | C470EZ1000-0105 | C470EZ1000-0106 | C470EZ1000-0107 | C470EZ1000-0108 | |
| | 200 mW | | | | | |
| | | 465 nm | 467.5 nm | 470 nm | 472.5 nm | 475 nm |
| Dominant Wavelength | | | | | | |

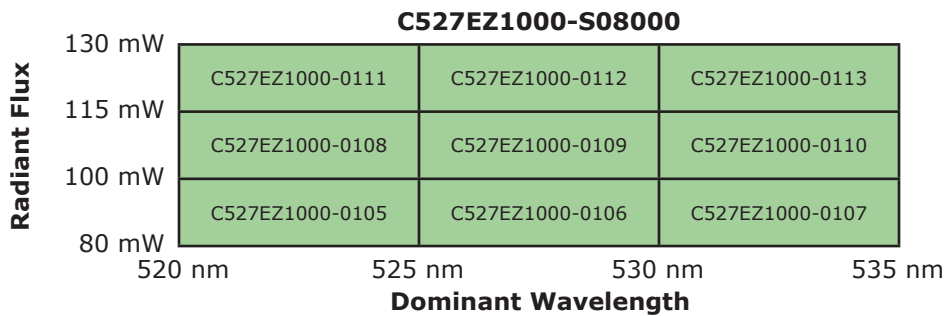
Standard Bins for CxxxEZ1000-Sxx000 (continued)

EZ-300

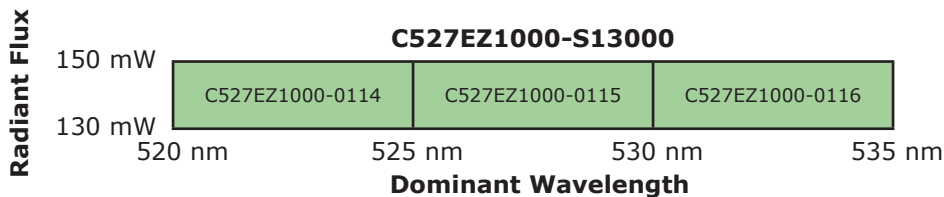


Green EZ1000

EZ-80

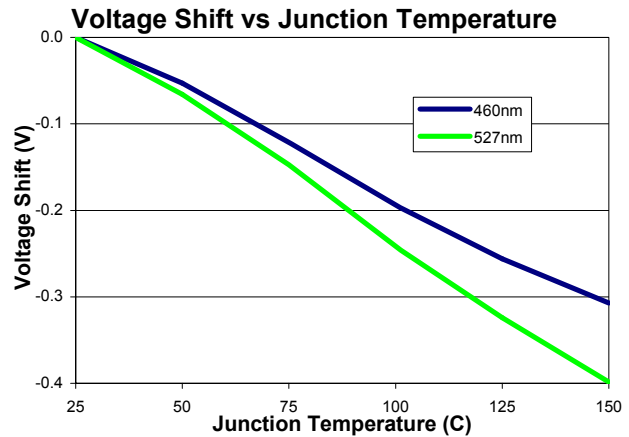
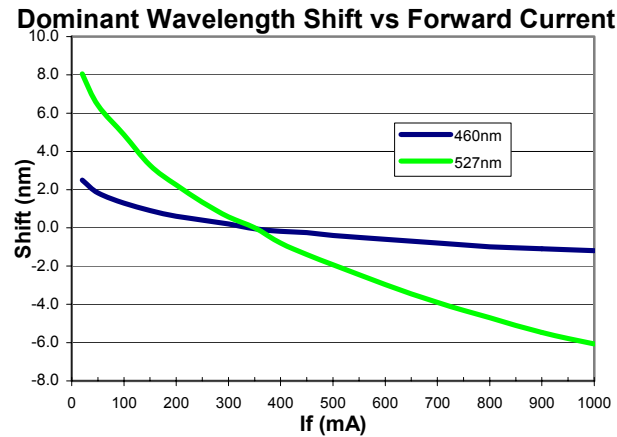
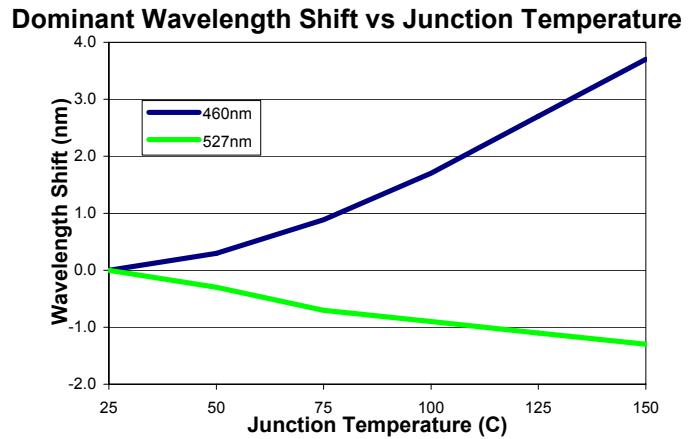
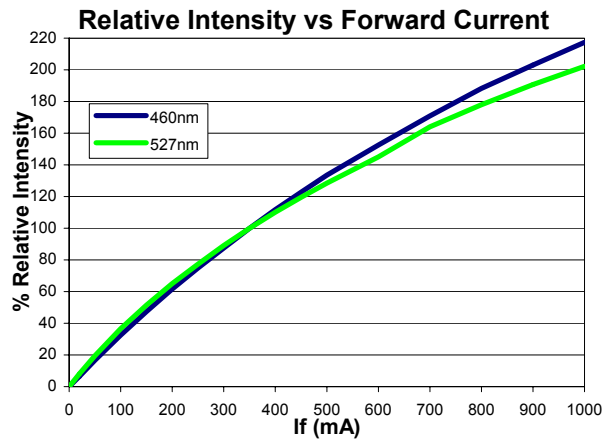
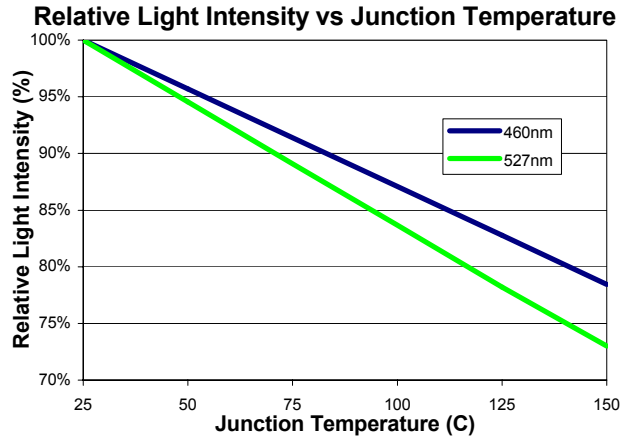
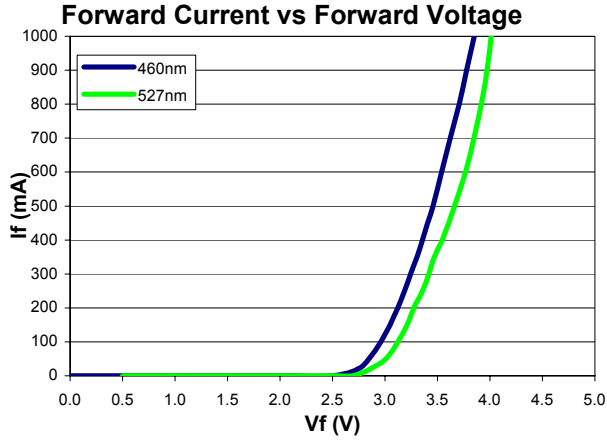


EZ-130



Characteristic Curves, $T_A = 25^\circ\text{C}$

This is a representative measurement for the EZ1000 LED product. Actual curves will vary slightly for the various radiant flux and dominant wavelength bins.



Radiation Pattern

This is a representative radiation pattern for the EZBright Power Chip LED product. Actual patterns will vary slightly for each chip.

